



LOW CAPACITANCE UNIDIRECTIONAL TVS DIODE

Product Summary

V _{BR (min)}	I _{PP (max)}	C _{T (typ)}
14.2V	1.5A	6.0pF

Description

This new generation TVS is designed to protect sensitive electronics from the damage due to ESD. The combination of small size and high ESD surge capability makes it ideal for use in portable applications such as cellular phones, digital cameras, and MP3 players.

Applications

- Cellular Handsets
- Portable Electronics
- · Computers and Peripheral

Features

- Ultra-Small, Low Profile Leadless Surface Mount Package (0.6mm * 0.3mm * 0.3mm)
- Provides ESD Protection per IEC 61000-4-2 Standard: Air ±15kV,
 Contact ±8kV
- 1 Channel of ESD Protection
- Low Channel Input Capacitance
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

Mechanical Data

- Case: X3-DFN0603-2
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin over Copper Leadframe, solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.0002 grams (Approximate)







Top View

Bottom View

Device Schematic

Ordering Information (Note 4)

Product	Compliance	Marking	Reel Size (inches)	Tape Width (mm)	Quantity per Reel
DESDALC14V2LP3-7	Standard	TA	7	8	10,000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-Free, "Green" and Lead-Free.
- 3. Halogen- and Antimony-Free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information

TA

TA = Product Type Marking Code Bar Denotes Cathode Side



Maximum Ratings (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	Conditions
Peak Pulse Power Dissipation	P_PP	30	W	8/20µs, per Figure 3
Peak Pulse Current	I _{PP}	1.5	Α	8/20µs, per Figure 3
ESD Protection – Contact Discharge	V _{ESD_Contact}	±8	kV	IEC 61000-4-2 Standard
ESD Protection – Air Discharge	V _{ESD_Air}	±15	kV	IEC 61000-4-2 Standard

Thermal Characteristics

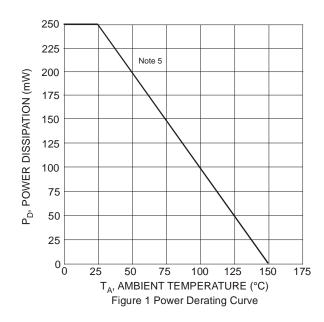
Characteristic	Symbol	Value	Unit
Package Power Dissipation (Note 6)	P_{D}	250	mW
Thermal Resistance, Junction to Ambient (Note 6)	$R_{ hetaJA}$	500	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +150	°C

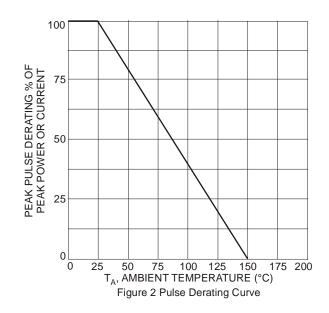
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Conditions
Breakdown Voltage	V_{BR}	14.2	1	17.0	V	I _R = 1mA
Leakage Current	I _{RM}	_	_	100	nA	V _{RWM} = 3V
Dynamic Impedance	R _d	_	2.6	_	Ω	Square Pulse, lpp = 1A, tp=2.5 μS
Channel Input Capacitance	C _T	_	6.0	_	pF	$V_R = 0V$, $f = 1MHz$

Notes:

- 5. Device mounted on FR-4 PCB pad layout (2oz copper) as shown on Diodes, Inc. suggested pad layout AP02001, which can be found on our website at http://www.diodes.com.
 6. Short duration pulse test used to minimize self-heating effect.







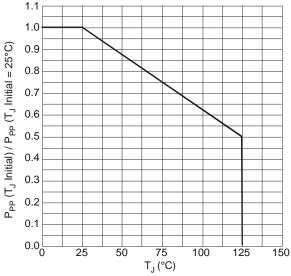


Figure 3 Relative Variation of Peak Pulse Power vs.
Initial Junction Temperature

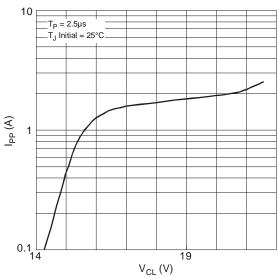


Figure 5 Clamping Voltage vs. Peak Pulse Current (Square Pulse, Typical Values)

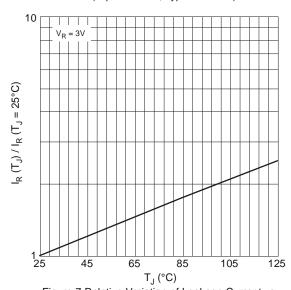


Figure 7 Relative Variation of Leakage Current vs.
Junction Temperature
(Typical Values)

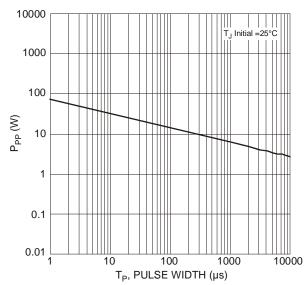


Figure 4 Peak Pulse Power vs. Exponential Pulse Duration

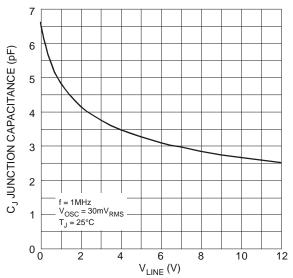


Figure 6 Junction Capacitance vs. Reverse Applied Voltage

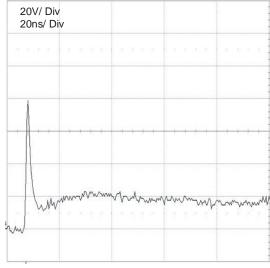


Figure 8 ESD Response to IEC6100-4-2 (+8kV Contact Discharge)



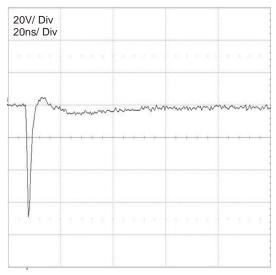


Figure 9 ESD Response to IEC6100-4-2 (-8kV Contact Discharge)

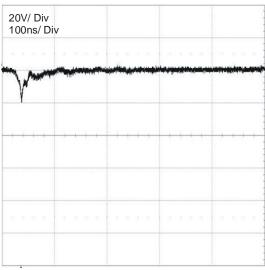


Figure 11 ESD Response to IEC6100-4-2 (-15kV Air Discharge)

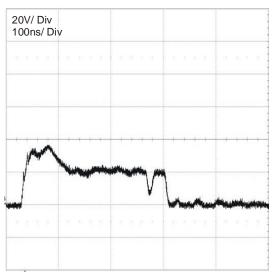


Figure 10 ESD Response to IEC6100-4-2 (+15kV Air Discharge)

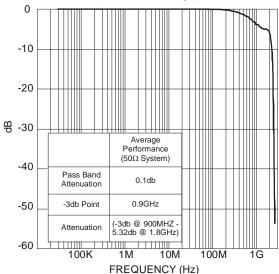
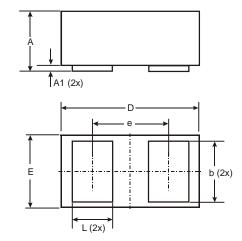


Figure 12 S21 Attenuation Measurement Results

Package Outline Dimensions

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.

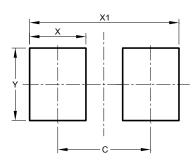


X3-DFN0603-2					
Dim	Min	Max	Тур		
Α	0.27	0.35	0.30		
A1	0.00	0.03	0.02		
b	0.19	0.29	0.24		
D	0.595	0.645	0.62		
Е	0.295	0.345	0.32		
е	-	-	0.355		
L	0.14	0.24	0.19		
All Dimensions in mm					



Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)		
С	0.380		
Х	0.230		
X1	0.610		
Υ	0.300		

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